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ON Semiconductor®

FDD3510H

Dual N & P-Channel PowerTrench[®] MOSFET N-Channel: 80V, 13.9A, 80m Ω P-Channel: -80V, -9.4A, 190m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 80m Ω at V_{GS} = 10V, I_D = 4.3A
- Max $r_{DS(on)}$ = 88m Ω at V_{GS} = 6V, I_D = 4.1A

Q2: P-Channel

- Max $r_{DS(on)}$ = 190m Ω at V_{GS} = -10V, I_D = -2.8A
- Max $r_{DS(on)}$ = 224m Ω at V_{GS} = -4.5V, I_D = -2.6A
- 100% UIL Tested
- RoHS Compliant

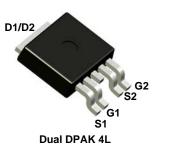


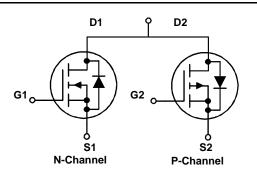


These dual N and P- Channel enhancement mode Power MOSFETs are produced using ON Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize on -state resistance and yet maintain superior switching performance.

Applications

- Inverter
- H-Bridge





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol			Parameter			Q1	Q2	Units	
V _{DS}	Drain to	Source Voltage				80	-80	V	
V _{GS}	Gate to	Source Voltage				±20	±20	V	
	Drain Cu	urrent - Continuous		T _C = 25°C		13.9	-9.4		
I _D		- Continuous		T _A = 25°C		4.3	-2.8	Α	
		- Pulsed				20	-10		
	Power D	issipation for Single Oper	ation	T _C = 25°C	(Note 1)	35	32		
PD			$T_A = 25^{\circ}C$ (Note 1a)			3.1		W	
				T _A = 25°C	(Note 1b)	1			
E _{AS}	Single P	ulse Avalanche Energy			(Note 3)	37	54	mJ	
T _J , T _{STG}	Operatin	ig and Storage Junction T	emperature Range			-55 to	°C		
Thermal Ch	naracteri	stics							
$R_{ ext{ heta}JC}$	Thermal	Resistance, Junction to 0	Case, Single Operation	for Q1	(Note 1)	3.5		°C/W	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Single Operation for Q2 (Note		(Note 1)	3	.9	0/11			
Package Ma	arking a	nd Ordering Inform	ation						
Device Ma	arking	Device	Package	Reel S	Size	Tape Widt	h Q	uantity	
FDD35	10H	FDD3510H	TO-252-4L	13	,	16mm 25		2500 units	

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I_D =250µA, V_{GS} = 0V I_D = -250µA, V_{GS} = 0V	Q1 Q2	80 -80			V
ΔΒV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C $I_D = -250\mu$ A, referenced to 25°C	Q1 Q2		84 -67	mV	/°(
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64V, V_{GS} = 0V$ $V_{DS} = -64V, V_{GS} = 0V$	Q1 Q2			1 -1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	Q1 Q2			±100 ±100	nA nA
On Chara	octeristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = V_{DS}, I_D = -250 \mu A$	Q1 Q2	2.0 -1.0	2.6 -1.6	4.0 -3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250µA, referenced to 25°C I_D = -250µA, referenced to 25°C	Q1 Q2		-6.7 4.6	mV	°C
-	Statia Draia ta Sauras On Desistanas	$V_{GS} = 10V, I_D = 4.3A$ $V_{GS} = 6.0V, I_D = 4.1A$ $V_{GS} = 10V, I_D = 4.3A, T_J = 125^{\circ}C$	Q1		64 70 121	80 88 152	
^r DS(on)	Static Drain to Source On Resistance	$V_{GS} = -10V, I_D = -2.8A$ $V_{GS} = -4.5V, I_D = -2.6A$ $V_{GS} = -10V, I_D = -2.8A, T_J = 125^{\circ}C$	Q2		153 184 259	190 224 322	mΩ
9 _{FS}	Forward Transconductance	$V_{DD} = 10V, I_D = 4.3A$ $V_{DD} = -5V, I_D = -2.8A$	Q1 Q2		15 6.8		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1 V _{DS} = 40V, V _{GS} = 0V, f = 1MHZ	Q1 Q2		600 660	800 880	pF
Coss	Output Capacitance		Q1		56	75	pF

$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	C _{oss}	Output Capacitance	Q2	Q1 Q2	56 50	75 70	pF
R Gate Resistance It = 1MHz O	C _{rss}	Reverse Transfer Capacitance	V _{DS} = -40V, V _{GS} = 0V, f = 1MHZ				pF
	Rg	Gate Resistance	f = 1MHz				Ω

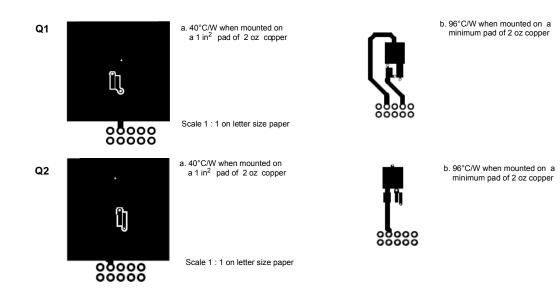
Switching Characteristics

t _{d(on)}	Turn-On Delay Time	Q1	Q1 Q2	7 6	13 11	ns
t _r	Rise Time	V _{DD} = 40V, I _D = 4.3A, V _{GS} = 10V, R _{GEN} = 6Ω	Q1 Q2	2 3	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = -40V, I _D = -2.8A,	Q1 Q2	16 25	29 40	ns
t _f	Fall Time	$V_{GS} = -10V, R_{GEN} = 6\Omega$	Q1 Q2	2 5	10 10	ns
Q _{g(TOT)}	Total Gate Charge	Q1	Q1 Q2	13 14	18 20	nC
Q _{gs}	Gate to Source Charge	– V _{GS} = 10V, V _{DD} = 40V, I _D = 4.3A – Q2 V _{GS} = -10V, V _{DD} = -40V, I _D = -2.8A	Q1 Q2	2.3 1.9		nC
Q _{gd}	Gate to Drain "Miller" Charge		Q1 Q2	3.2 2.9		nC

Electrica	al Characteristics $T_J = 25^{\circ}C$ unl	ess otherwise noted						
Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-Sou	Irce Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.6A$ $V_{GS} = 0V, I_S = -2.6A$	(Note 2) (Note 2)			0.8 -0.8	1.2 -1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 4.3A, di/dt = 100A/s		Q1 Q2		29 30	46 48	ns
Q _{rr}	Reverse Recovery Charge	Q2 I _F = -2.8A, di/dt = 100A/s		Q1 Q2		28 30	45 48	nC

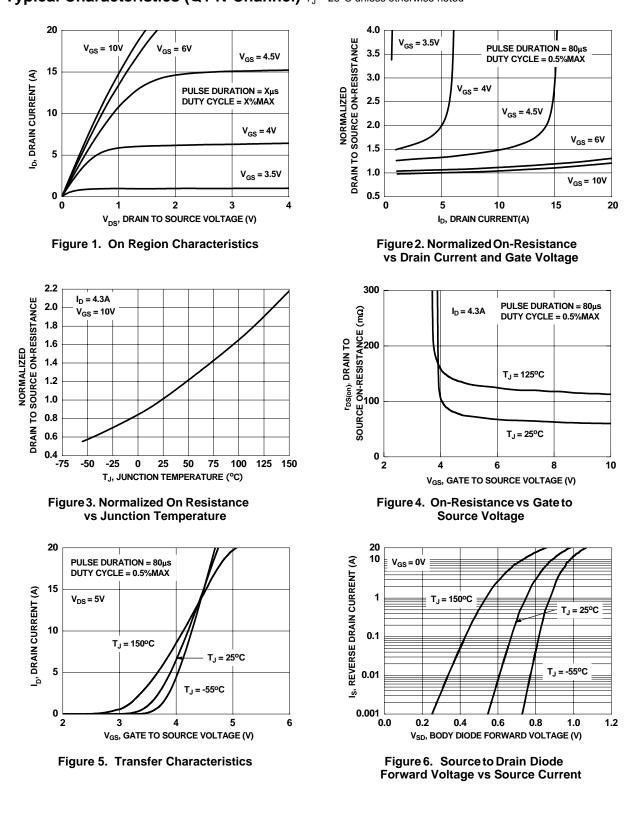
Notes:

1. R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

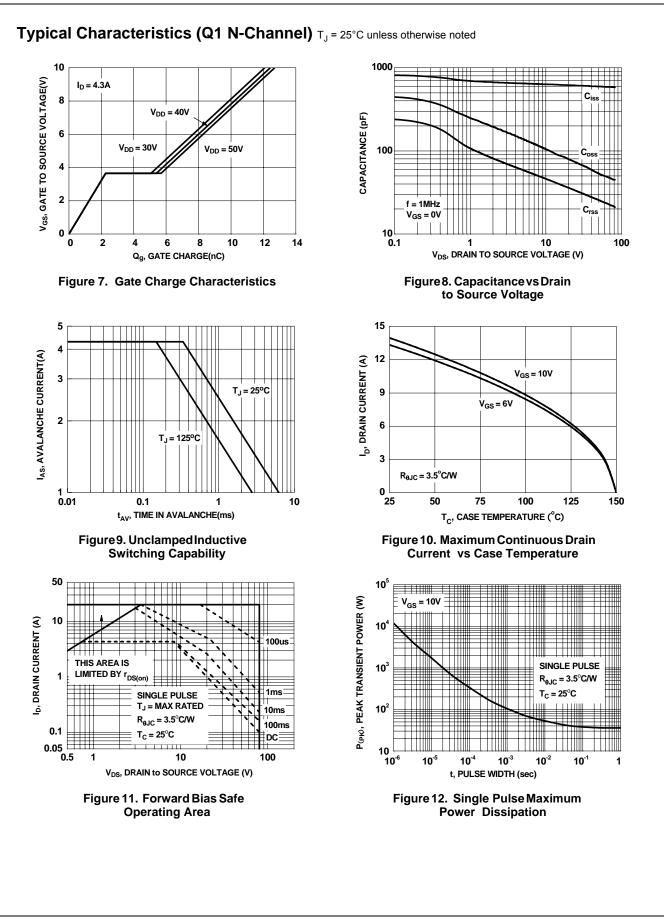


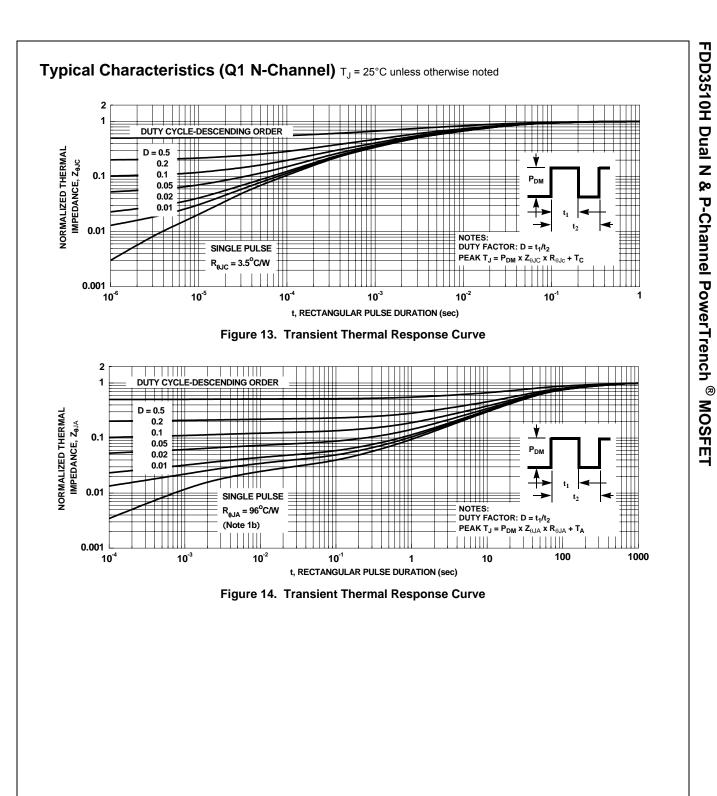
2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.

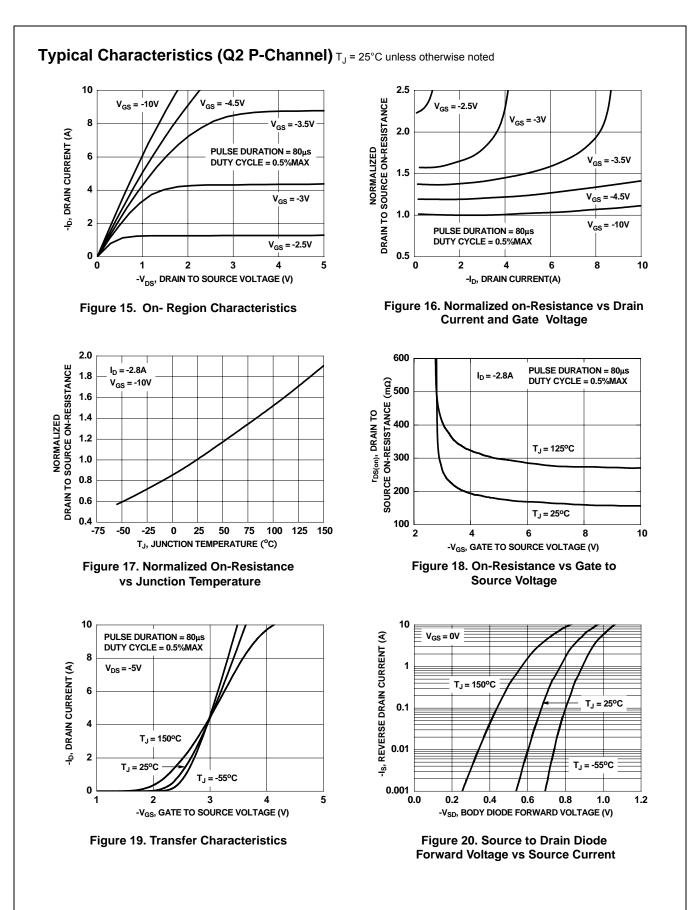
3. Starting $T_J = 25^{\circ}$ C, N-ch: L = 3mH, $I_{AS} = 5$ A, $V_{DD} = 80$ V, $V_{GS} = 10$ V; P-ch: L = 3mH, $I_{AS} = -6$ A, $V_{DD} = -80$ V, $V_{GS} = -10$ V.



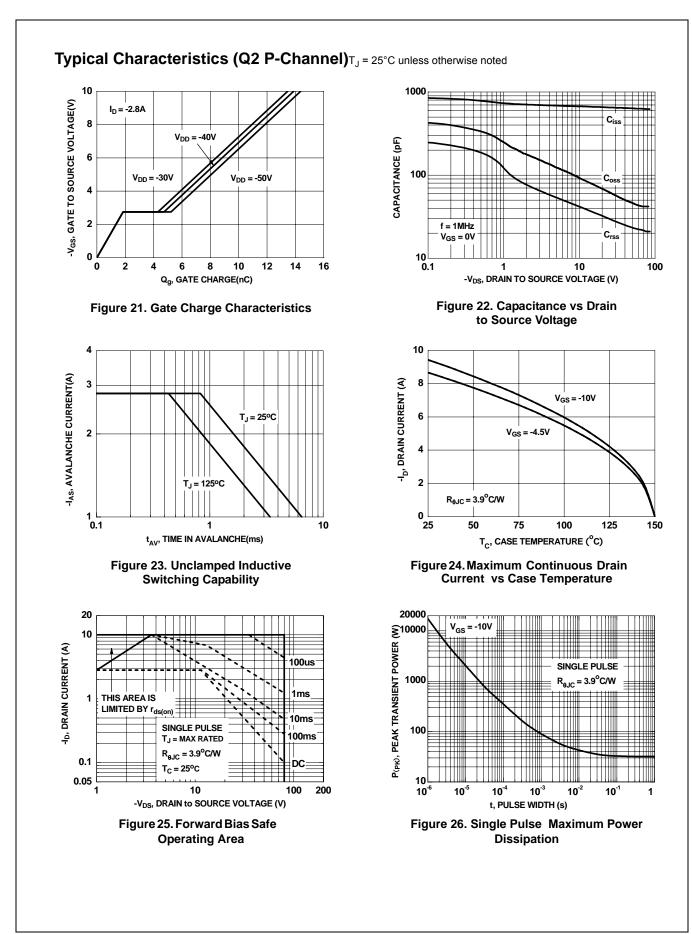
Typical Characteristics (Q1 N-Channel) T_J = 25°C unless otherwise noted



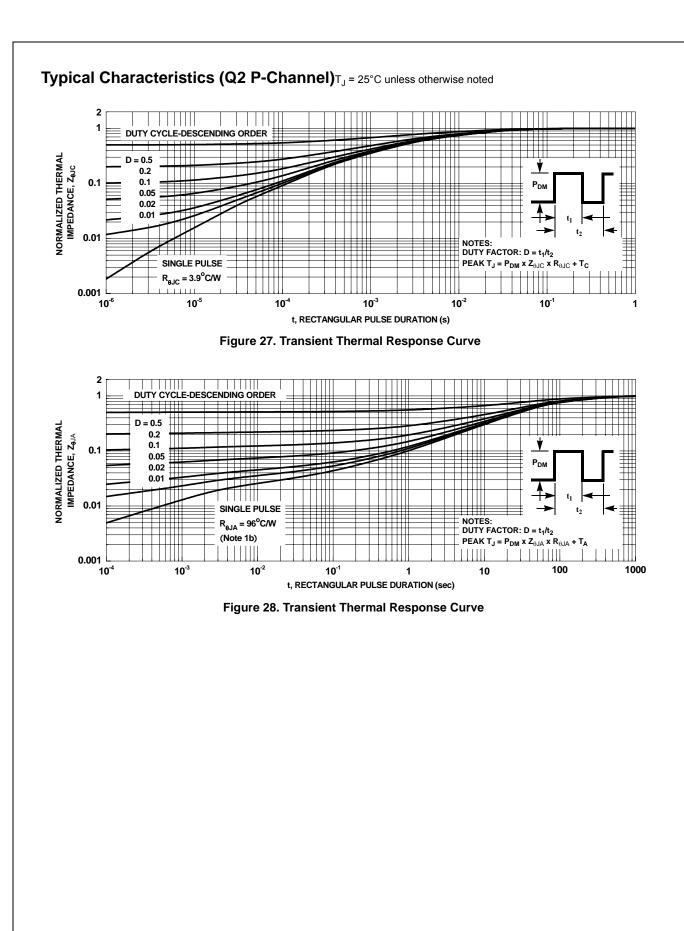












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